

IN THE CLAIMS:

Please amend the claims as shown below. The status of the claims after amendment will be as follows:

1. (currently amended) A cap-shaped lid for use with a generally flat base to seal an electronic device comprising a top portion, a wall structure extending around an entire periphery of the top portion and having an upper end connected to the top portion and a lower end, a lip connected to the lower end of the wall structure around an entire periphery of the wall structure and extending outwards from an outer surface of the wall structure by 10 - 500  $\mu$ m, and solder applied to an inner surface of the lid on at least the a portion of the ~~cap-shaped~~ lip.

2. (original) A lid as claimed in claim 1 wherein the lip is curved with respect to the wall structure.

3. (original) A lid as claimed in claim 1 wherein the top surface of the lid is polygonal.

4. (currently amended) A lid as claimed in claim 1 wherein the wall structure extends substantially perpendicularly ~~from~~ with respect to the top surface.

5. (currently amended) A lid as claimed in claim 1 wherein solder is provided on ~~an~~ the entire inner surface of the lid.

6. (original) A packaged electronic part comprising a generally flat base, an electronic device mounted on a top surface of the base, and a cap-shaped lid according to claim 1 covering the electronic device and soldered to the top surface of the base.

7. (currently amended) A method of manufacturing a cap-shaped lid ~~for a package for an electronic device as claimed in claim 1~~ comprising performing drawing of a metal sheet having solder on a first side of the metal sheet to form a recessed shape ~~having a~~ including the top portion, a ~~the~~ wall structure ~~extending from the top portion around an entire periphery thereof,~~ and a flange extending outwards from the wall structure with the first side of the metal strip on the interior of the recessed shape, and then severing the flange ~~to define a lip extending~~ around an entire periphery of the recessed shape ~~and extending at a distance of 10 - 500  $\mu$ m from an outer side of the wall structure to define the lip.~~

8. (original) A method as claimed in claim 7 including severing the flange with a punch.

9. (original) A method as claimed in claim 7 including severing the flange in a portion which is curved with respect to the wall structure.

Claim 10 (cancelled)

11. (new) A lid as claimed in claim 1 wherein the wall structure, the top portion, and the lip are formed from a single metal sheet.

12. (new) A lid as claimed in claim 5 wherein the solder comprises a layer of solder formed on the inner surface of the wall structure.